## ■ Laser Marking System for IC Packaging

**Optimum laser oscillator for your application can be selected from fundamental, SHG or THG.**

## Features

This is a laser marking system that marks on a IC package in JEDEC tray.

- You can select the optimum laser oscillator (fundamental mode, SHG, or THG) that best suits your application.
- Detect the image of a IC package in a tray pocket and mark on it.
- Positioning detection feature (option) ensures highly accurate positioning and enables area-marking on multiple workpieces at a time.
- Image check after marking and check of marked letters can be performed.
- Dual stage is available.
- Only non-defective item in a tray can be discharged. (Defective and non-defective items can be distinguished.)
- Built-in dust collector.

## Specifications

| Package | TSOP, TSSOP, TQFP, BGA, CSP, WL-CSP |
|---|---|
| Dimensions | 2000W x 1440D x 1750H mm |
| Loader & unloader | 20 pcs of JEDEC tray |
| Dust collector | Built-in |
| Image check | Pre-check and after-check (Please contact our sales person for details.) |